



Premstaetten, Jan. 15, 2019

PCN38-2018 (Change of Polyimide Wafer Coating Material used in our Fab B)

Dear Customer,

This is to formally inform you that ams AG received a “Product Discontinuation Notice” from our supplier, Fujifilm Electronic Materials, that is directly affecting the fab B product(s) that we are delivering to you. The supply of currently used type of Polyimide Wafer Coating (DURIMIDE 9005) will be discontinued and replaced by another type (FB5610-12) which is proposed as equivalent replacement coating material from Fujifilm Electronic Materials.

In order to reasonably protect the supply of your product, ams AG is currently qualifying this replacement coating material.

The following product(s) will be affected:

<u>product</u>	<u>Material Description</u>	<u>material ID</u>
AS5600-ASOT	AS5600-ASOT SOIC8 LF T&RDP	191240005
AS5600-ASOM	AS5600-ASOM SOIC8 LF T&RDP	191240012
AS5601-ASOT	AS5601-ASOT SOIC8 LF T&RDP	191240010
AS5601-ASOM	AS5601-ASOM SOIC8 LF T&RDP	191240011

Note: this only affects wafer material produced in our Fab B. TSMC wafers are not affected



Timing of change:

ams AG qualification is ongoing and will be finished in Q2 / 2019.
Material with new polyimid coating will be delivered from Q4 / 2019 onwards.

Set of qualification tests:

ams AG is qualifying the new coating material based on AEC-Q100 standards.
Detailed results of the qualification will be available upon request.

If you do have further questions please do not hesitate to contact us.

Please be advised that unless we receive your written refusal concerning this PCN within 30 days,
the PCN shall be deemed accepted.

Best regards,

A handwritten signature in black ink, appearing to read 'Herwig Klimesch'.

Herwig Klimesch
ams AG
Vice President Quality